

Diode

Silicon Carbide Schottky Diode

IDH16G120C5

5th Generation CoolSiC™ 1200 V SiC Schottky Diode

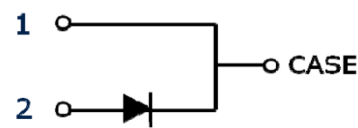
Final Datasheet

Rev. 2.2 2021-03-01

CoolSiC™ SiC Schottky Diode

Features:

- Revolutionary semiconductor material - Silicon Carbide
- No reverse recovery current / No forward recovery
- Temperature independent switching behavior
- Low forward voltage even at high operating temperature
- Tight forward voltage distribution
- Excellent thermal performance
- Extended surge current capability
- Specified dv/dt ruggedness
- Qualified according to JEDEC¹⁾ for target applications
- Pb-free lead plating; RoHS compliant



Benefits

- System efficiency improvement over Si diodes
- Enabling higher frequency / increased power density solutions
- System size / cost savings due to reduced heatsink requirements and smaller magnetics
- Reduced EMI
- Highest efficiency across the entire load range
- Robust diode operation during surge events
- High reliability
- RelatedLinks: www.infineon.com/sic



Applications

- Solar inverters
- Uninterruptable power supplies
- Motor drives
- Power Factor Correction

Package pin definitions

- Pin 1 and backside – cathode
- Pin 2 – anode



Key Performance and Package Parameters

Type	V _{DC}	I _F	Q _C	T _{j,max}	Marking	Package
IDH16G120C5	1200V	16A	57nC	175°C	D1612C5	PG-TO220-2-1

1) J-STD20 and JESD22

Table of Contents

Description	2
Table of Contents	3
Maximum Ratings	4
Thermal Resistances	4
Electrical Characteristics	5
Electrical Characteristics Diagram	6
Package Drawings	9
Revision History	10
Disclaimer	11

Maximum ratings

Parameter	Symbol	Value	Unit
Repetitive peak reverse voltage	V_{RRM}	1200	V
Continues forward current for $R_{th(j-c,max)}$ $T_C = 145^{\circ}C$, $D=1$ $T_C = 135^{\circ}C$, $D=1$ $T_C = 25^{\circ}C$, $D=1$	I_F	16 19 40	A
Surge non-repetitive forward current, sine halfwave $T_C=25^{\circ}C$, $t_p=10ms$ $T_C=150^{\circ}C$, $t_p=10ms$	$I_{F,SM}$	140 120	A
Non-repetitive peak forward current $T_C = 25^{\circ}C$, $t_p=10 \mu s$	$I_{F,max}$	850	A
i^2t value $T_C = 25^{\circ}C$, $t_p=10 ms$ $T_C = 150^{\circ}C$, $t_p=10 ms$	$\int i^2 dt$	99 71	A ² s
Diode dv/dt ruggedness $V_R=0...960V$	dv/dt	150	V/ns
Power dissipation $T_C = 25^{\circ}C$	P_{tot}	250	W
Operating and storage temperature	$T_j; T_{stg}$	-55...175	$^{\circ}C$
Soldering temperature, wavesoldering only allowed at leads, 1.6mm (0.063 in.) from case for 10 s	T_{sold}	260	$^{\circ}C$
Mounting torque M3 and M4 screws	M	0.7	Nm

Thermal Resistances

Thermal Resistances						
Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Characteristic						
Diode thermal resistance, junction – case	R _{th(j-c)}		-	0.46	0.60	K/W
Thermal resistance, junction – ambient	R _{th(j-a)}	leaded	-	-	62	K/W

Electrical Characteristics

Static Characteristics, at T_j=25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Static Characteristic						
DC blocking voltage	V _{DC}	T _j = 25°C	1200	-	-	V
Diode forward voltage	V _F	I _F = 16A, T _j =25°C	-	1.65	1.95	V
		I _F = 16A, T _j =150°C	-	2.25	2.85	
Reverse current	I _R	V _R =1200V, T _j =25°C		5.5	80	μA
		V _R =1200V, T _j =150°C		28	410	

Dynamic Characteristics, at T_j=25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Dynamic Characteristics						
Total capacitive charge	Q _C	V _R =800V, T _J =150°C $Q_C = \int_0^{V_R} C(V)dV$	-	57	-	nC
Total Capacitance	C	V _R =1 V, f=1 MHz	-	730	-	pF
		V _R =400 V, f=1 MHz	-	52	-	
		V _R =800 V, f=1 MHz	-	40	-	

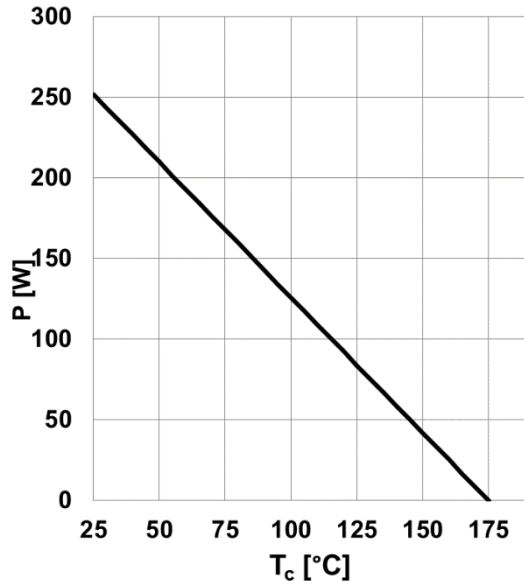


Figure 1. Power dissipation as a function of case temperature, $P_{tot}=f(T_c, R_{th(j-c),max})$

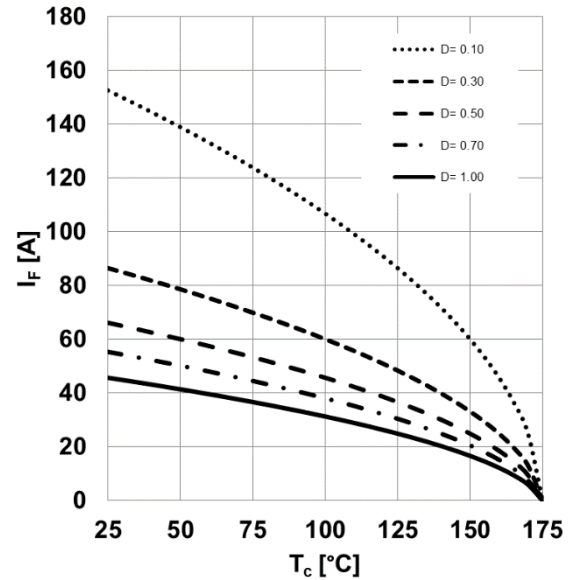


Figure 2. Diode forward current as function of temperature, $T_j \leq 175^\circ\text{C}$, $R_{th(j-c),max}$, parameter D =duty cycle, V_{th} , R_{diff} @ $T_j=175^\circ\text{C}$

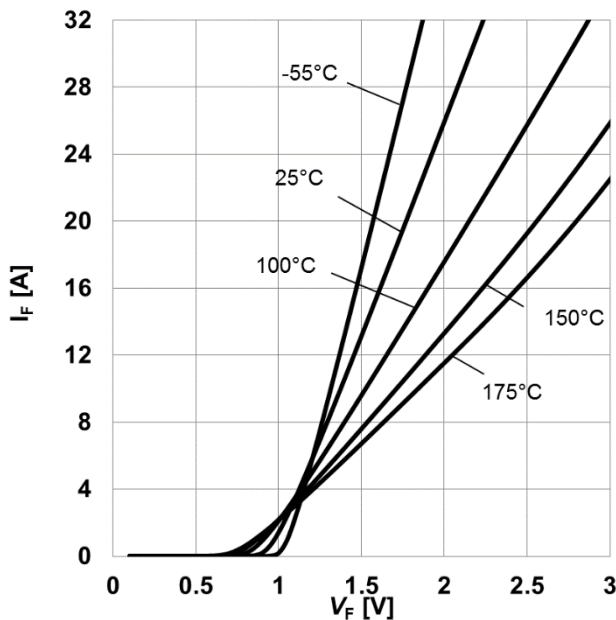


Figure 3. Typical forward characteristics, $I_F=f(V_F)$, $t_p=10\text{ }\mu\text{s}$, parameter: T_j

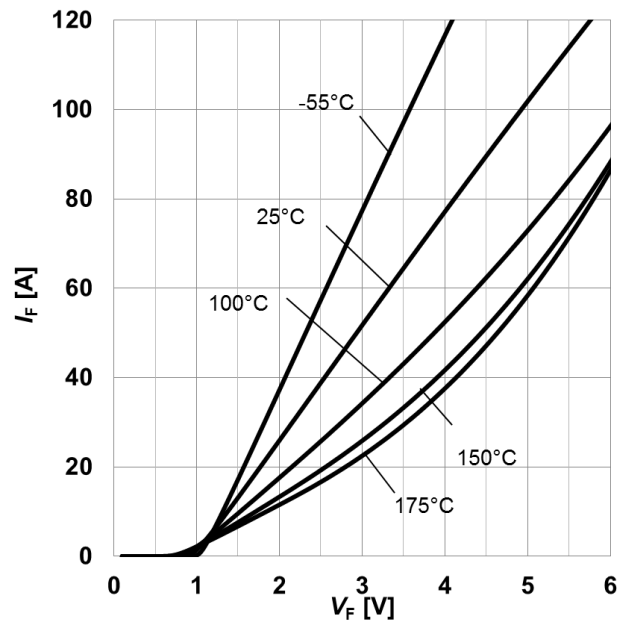


Figure 4. Typical forward characteristics in surge current, $I_F=f(V_F)$, $t_p=10\text{ }\mu\text{s}$, parameter: T_j

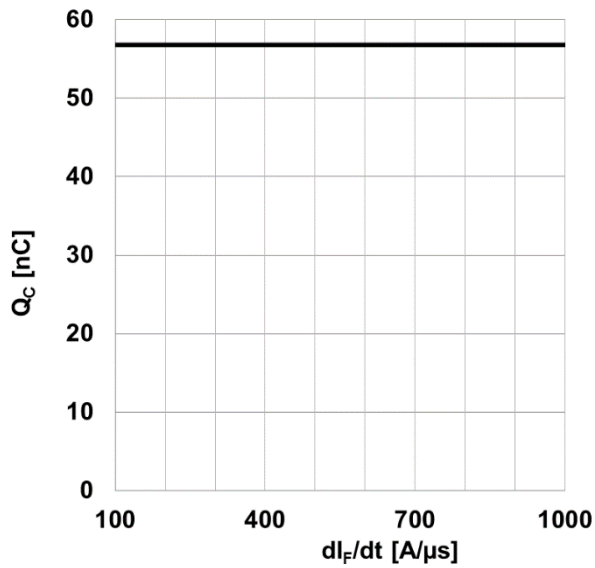


Figure 5. **Typical capacitive charge as function of current slope¹**, $Q_C=f(di_F/dt)$, $T_J=150^\circ\text{C}$
1) Only capacitive charge, guaranteed by design.

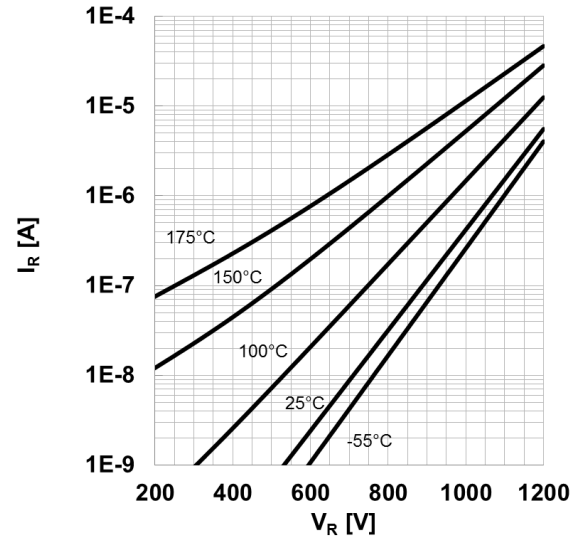


Figure 6. **Typical reverse current as function of reverse voltage**, $I_R=f(V_R)$, parameter: T_J

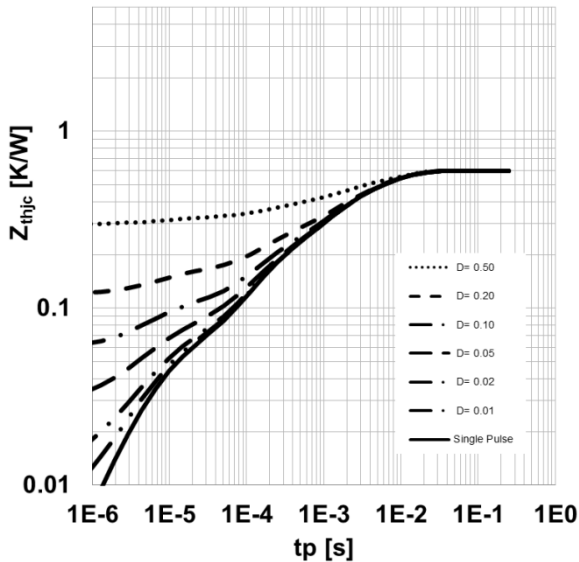


Figure 7. **Max. transient thermal impedance**, $Z_{th,jc}=f(t_P)$, parameter: $D=t_P/T$

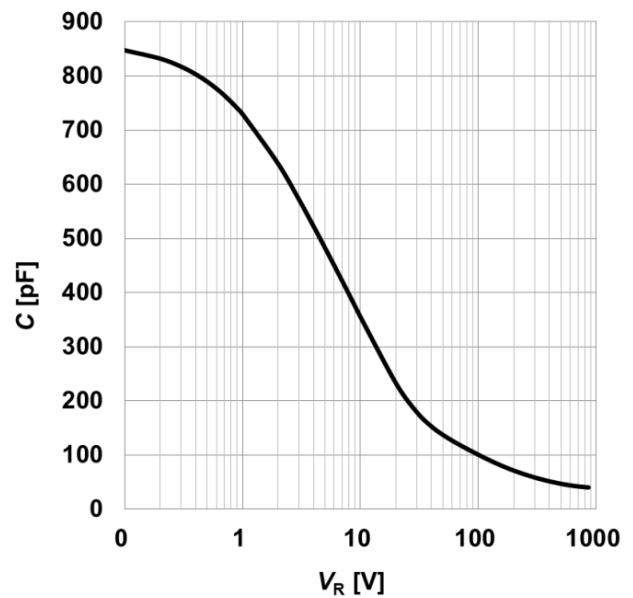


Figure 8. **Typical capacitance as function of reverse voltage**, $C=f(V_R)$; $T_J=25^\circ\text{C}$; $f=1\text{ MHz}$

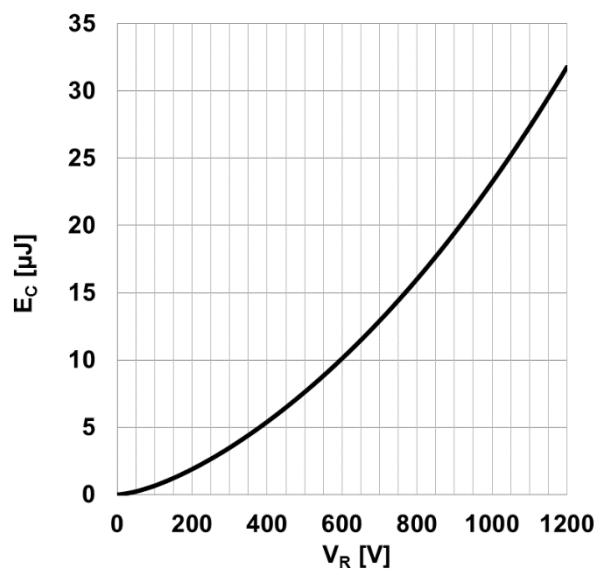
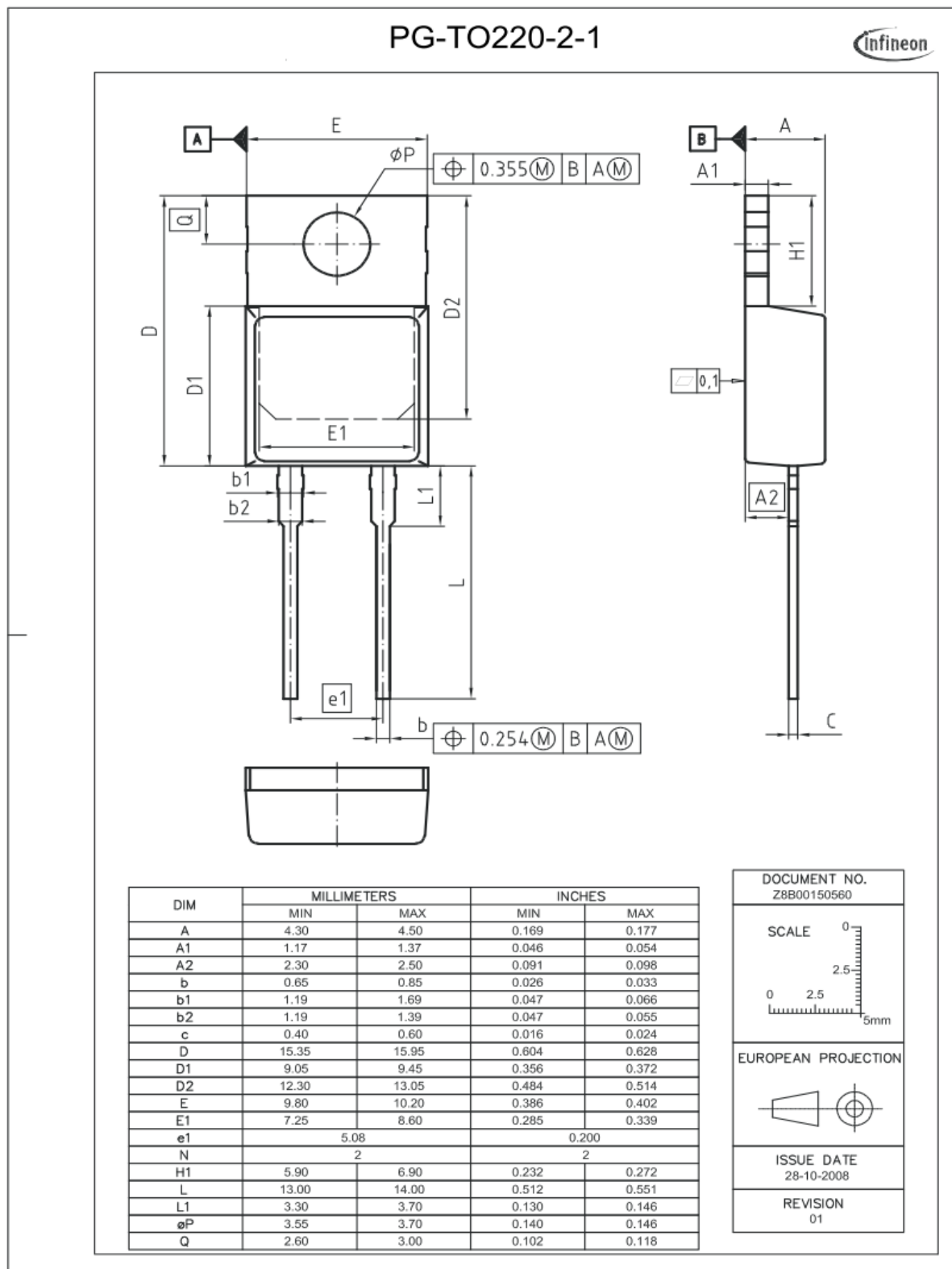


Figure 9. **Typical capacitively stored energy as function of reverse voltage,**

$$E_C = \int_0^{V_R} C(V)VdV$$



Revision History

IDH16G120C5

Revision: 2021-03-01, Rev. 2.2

Previous Revision:

Revision	Date	Subjects (major changes since last version)
2.0	2015-09-03	Final data sheet
2.1	2017-07-21	Editorial Changes
2.2	2021-03-01	Increased dv/dt ruggedness

We Listen to Your Comments

Any information within this document that you feel is wrong, unclear or missing at all?

Your feedback will help us to continuously improve the quality of this document.

Please send your proposal (including a reference to this document) to: erratum@infineon.com

Published by
Infineon Technologies AG
81726 München, Germany
© Infineon Technologies AG 2021.
All Rights Reserved.

IMPORTANT NOTICE

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie"). With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

For further information on the product, technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies office (www.infineon.com).

Please note that this product is not qualified according to the AEC Q100 or AEC Q101 documents of the Automotive Electronics Council.

WARNINGS

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Infineon:](#)

[IDH16G120C5XKSA1](#)